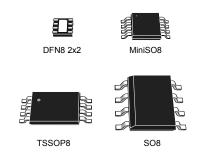


LM2904, LM2904A LM2904W, LM2904AW

Datasheet

Low-power dual operational amplifier



Features

- · Frequency compensation implemented internally
- · Large DC voltage gain: 100 dB
- Wide bandwidth (unity gain): 1.1 MHz (temperature compensated)
- Very low supply current/amplifier, essentially independent of supply voltage
- Low input bias current: 20 nA (temperature compensated)
- · Low input offset current: 2 nA
- · Input common-mode voltage range includes negative rail
- Differential input voltage range equal to the power supply voltage
- Large output voltage swing 0 V to [(V_{CC} +) -1.5 V]

Description

This circuit consists of two independent, high gain operational amplifiers (op amps) that have frequency compensation implemented internally. They are designed specifically for automotive and industrial control systems. The circuit operates from a single power supply over a wide range of voltages. The low power supply drain is independent of the magnitude of the power supply voltage.

Application areas include transducer amplifiers, DC gain blocks and all the conventional op amp circuits which can now be more easily implemented in single power supply systems. For example, these circuits can be directly supplied from the standard 5 V which is used in logic systems and easily provides the required electronic interfaces without requiring any additional power supply.

In linear mode, the input common-mode voltage range includes ground and the output voltage can also swing to ground, even though operated from a single power supply.

Maturity status link					
	Enhanced V _{IO}	Enhanced ESD			
LM2904					
LM2904A	✓				
LM2904W		✓			
LM2904AW	✓	✓			

Related products				
TSB572	Dual op-amps for low- power consumption (380 µA with 2.5 MHz GBP)			
LM2902 LM2902W	Quad op-amps version			
LM2904WH LM2904AH	High temperature version (150 °C)			

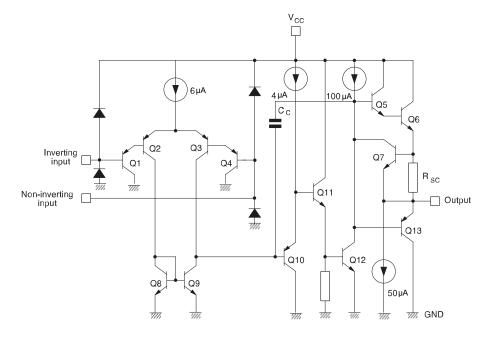


Schematic diagram

 $\Lambda^{\vec{C}C}$ 100 µA Q5 Q6 C_C Q2 Q3 Inverting Q7 input R_{SC} mm Q11 Non-inverting Output input Q10 Q12 Q9 Q8 50µA GND m

Figure 1. Schematic diagram (LM2904, LM2904A)

Figure 2. Schematic diagram (LM2904W, LM2904AW)

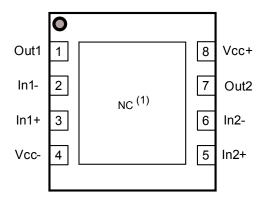


DS0508 - Rev 18 page 2/26



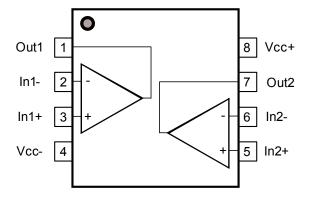
Package pin connections

Figure 3. DFN8 2x2 package pin connections (top view)



1. The exposed pad of the DFN8 2x2 can be connected to (VCC-) or left floating.

Figure 4. MiniSO8, TSSOP8, and SO8 package pin connections (top view)



DS0508 - Rev 18 page 3/26



Absolute maximum ratings and operating conditions

Table 1. Absolute maximum ratings

Symbol	Parameter		Value	Unit
V _{CC}	Supply voltage (1)		±16 or 32	
W	Differential input voltage (LM2904, LM2904A	A) ⁽²⁾	±32	
V _{id}	Differential input voltage (LM2904W, LM2904AW) (2)		-0.3 to V _{CC} +0.3	V
	Input voltage (LM2904, LM2904A)		-0.3 to 32	
V _{in}	Input voltage (LM2904W, LM2904AW)		-0.3 to V _{CC} +0.3	
	Output short-circuit duration (3)		Infinite	s
	Input current : V _{in} driven negative		5 mA in DC or 50 mA in AC, (duty cycle = 10 %, T = 1 s)	
l _{in}	Input current : V _{in} driven positive above AMF	R value (5)	0.4	mA
T _{oper}	Operating free-air temperature range		-40 to 125	
T _{stg}	Storage temperature range		-65 to 150	
Tj	Maximum junction temperature		150	
		DFN8 2x2	57	
D	Thermal registance junction to ambient (6)	MiniSO8	190	
R _{thja}	Thermal resistance junction to ambient (6)	TSSOP8	120	
		SO8	125	°C/W
		MiniSO8	39	
R _{thjc}	Thermal resistance junction to case (6)	TSSOP8	37	
		SO8	40	
	HBM: human body model (LM2904, LM2904	łA) ⁽⁷⁾	300	
ESD	HBM: human body model (LM2904W, LM2904AW) (7) MM: machine model (8)		2000	V
LOD			200	
	CDM: charged device model (9)		1.5	kV

- 1. All voltage values, except differential voltage are with respect to network ground terminal.
- 2. Differential voltages are the non-inverting input terminal with respect to the inverting input terminal.
- 3. Short-circuits from the output to V_{CC} can cause excessive heating if $(V_{cC}^+) > 15 \text{ V}$. The maximum output current is approximately 40 mA, independent of the magnitude of V_{CC} . Destructive dissipation can result from simultaneous short-circuits on all amplifiers.
- 4. This input current only exists when the voltage at any of the input leads is driven negative. It is due to the collector-base junction of the input PNP transistor becoming forward-biased and thereby acting as an input diode clamp. In addition to this diode action, there is NPN parasitic action on the IC chip. This transistor action can cause the output voltages of the op amps to go to the V_{CC} voltage level (or to ground for a large overdrive) for the time during which an input is driven negative. This is not destructive and normal output is restored for input voltages above -0.3 V.
- 5. The junction base/substrate of the input PNP transistor polarized in reverse must be protected by a resistor in series with the inputs to limit the input current to 400 μ A max (R = (V_{in} 32 V)/400 μ A).
- 6. Short-circuits can cause excessive heating and destructive dissipation. Values are typical.
- 7. Human body model: a 100 pF capacitor is charged to the specified voltage, then discharged through a 1.5 kΩ resistor between two pins of the device. This is done for all couples of connected pin combinations while the other pins are floating.
- 8. Machine model: a 200 pF capacitor is charged to the specified voltage, then discharged directly between two pins of the device with no external series resistor (internal resistor $< 5 \Omega$). This is done for all couples of connected pin combinations while the other pins are floating.

DS0508 - Rev 18 page 4/26



Absolute maximum ratings and operating conditions

9. Charged device model: all pins and the package are charged together to the specified voltage and then discharged directly to the ground through only one pin. This is done for all pins.

Table 2. Operating conditions

Symbol	Parameter	Value	Unit
V _{CC}	Supply voltage	3 to 30	
V.	Common mode input voltage range T _{amb} = 25 °C	V _{CC-} to V _{CC+} - 1.5	V
V _{icm}	Common mode input voltage range T _{min} ≤ T _{amb} ≤ T _{max}	V _{CC-} to V _{CC+} - 2	
T _{oper}	Operating free-air temperature range	-40 to 125	°C

DS0508 - Rev 18 page 5/26



4 Electrical characteristics

Table 3. V_{CC} + = 5 V, V_{CC} = ground, V_{O} = 1.4 V, R_{L} connected to GND, T_{amb} = 25 °C (unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Unit		
	Input offset voltage, T _{amb} = 25 °C, LM2904, LM2904W ⁽¹⁾		2	7			
V	Input offset voltage, T _{amb} = 25 °C, LM2904A, LM2904AW ⁽¹⁾		1	2			
V_{io}	Input offset voltage, T _{min} ≤ T _{amb} ≤ T _{max} , LM2904, LM2904W (1)			9	mV		
	Input offset voltage, T _{min} ≤ T _{amb} ≤ T _{max} , LM2904A, LM2904AW ⁽¹⁾			4			
ΔV _{io} /ΔΤ	Input offset voltage drift		7	30	μV/°C		
	Input offset current, T _{amb} = 25 °C		2	30	A		
l _{io}	Input offset current, T _{min} ≤ T _{amb} ≤ T _{max}			40	nA		
ΔΙ _{ίΟ} /ΔΤ	Input offset current drift		10	300	pA/°C		
	Input bias current, T _{amb} = 25 °C ⁽²⁾		20	150			
l _{ib}	Input bias current, T _{min} ≤ T _{amb} ≤ T _{max} (2)			200	nA		
	Large signal voltage gain, V_{CC} ⁺ = 15 V, R_L = 2 k Ω , V_0 = 1.4 V to 11.4 V, T_{amb} = 25 °C						
A _{vd}	Large signal voltage gain, $V_{CC}^+ = 15$ V, $R_L = 2$ k Ω , $V_0 = 1.4$ V to 11.4 V, $T_{min} \le T_{amb} \le T_{max}$	25			V/mV		
	Supply voltage rejection ratio, V_{CC} + = 5 V to 30 V, V_{icm} = 0 V, T_{amb} = 25 °C	65	100		_		
SVR	Supply voltage rejection ratio, $V_{CC}^+ = 5 \text{ V}$ to 30 V, $V_{icm} = 0 \text{ V}$, $T_{min} \le T_{amb} \le T_{max}$	65			dB		
	Supply current, all amp, no load, T_{amb} = 25 °C, V_{CC} + = 5 V		0.7	1.2			
I _{CC}	Supply current, all amp, no load, T _{min} ≤ T _{amb} ≤ T _{max} , V _{CC} ⁺ = 30 V			2	mA		
CMD	Common-mode rejection ratio, V_{CC}^{+} = 30 V, V_{icm} = 0 V to 28.5 V, T_{amb} = 25 °C	70	85		4D		
CMR	Common-mode rejection ratio, $V_{CC}^{+} = 30 \text{ V}$, $V_{icm} = 0 \text{ V}$ to 28 V, $V_{min} \leq T_{amb} \leq T_{max}$	60			dB		
I _{source}	Output short-circuit current, V_{CC} + = 15 V, V_{o} = 2 V, V_{id} = 1 V	20	40	60	mΛ		
1	Output sink current, V _O = 2 V, V _{CC +} = 15 V	10	20		mA		
I _{sink}	Output sink current, V _O = 0.2 V, V _{CC +} = 15 V	12	50		μA		
	High-level output voltage (V _{CC} $^+$ = 30 V), T _{amb} = 25 °C, R _L = 2 k Ω	26					
	High-level output voltage (V _{CC} ⁺ = 30 V), T _{min} ≤ T _{amb} ≤ T _{max}	26	27				
V _{OH}	High-level output voltage (V_{CC} + = 30 V), T_{amb} = 25 °C, R_L = 10 k Ω	27			V		
	High-level output voltage (V _{CC} ⁺ = 30 V), T _{min} ≤ T _{amb} ≤ T _{max}	27	28				
	Low-level output voltage (R _L = 10 k Ω), T _{amb} = 25 °C		5	20			
V_{OL}	Low-level output voltage ($R_L = 10 \text{ k}\Omega$), $T_{min} \le T_{amb} \le T_{max}$			20	mV		

DS0508 - Rev 18 page 6/26



Symbol	Parameter	Min.	Тур.	Max.	Unit
SR	Slew rate, V_{CC} ⁺ = 15 V, V_{in} = 0.5 to 3 V, R_L = 2 k Ω , C_L =100 pF, unity gain, T_{amb} = 25 °C	0.3	0.6		V/µs
Six	Slew rate, V_{CC} ⁺ = 15 V, V_{in} = 0.5 to 3 V, R_L = 2 k Ω , C_L =100 pF, unity gain, $T_{min} \le T_{amb} \le T_{max}$	0.2			ν/μ5
GBP	Gain bandwidth product, f = 100 kHz, V_{CC} + = 30 V, V_{in} = 10 mV, R_L = 2 k Ω , C_L = 100 pF	0.7	1.1		MHz
THD	Total harmonic distortion, f = 1 kHz, A_V = 20 dB, R_L = 2 k Ω , V_o = 2 V_{pp} , C_L = 100 pF, V_{CC} + = 30 V		0.02		%
e _n	Equivalent input noise voltage, f = 1 kHz, R_S = 100 Ω , V_{CC} + = 30 V		55		nV/√Hz
V _{O1} /V _{O2}	Channel separation, 1 kHz ≤ f ≤ 20 kHz ⁽³⁾		120		dB

^{1.} $V_O = 1.4 \text{ V}$, 5 V < V_{CC} $^+$ < 30 V, 0 V < V_{ic} < (V_{CC} $^+$) - 1.5 V

DS0508 - Rev 18 page 7/26

^{2.} The direction of the input current is out of the IC. This current is essentially constant as long as the output is not saturated, so there is no change in the loading charge on the input lines.

^{3.} Due to the proximity of external components, ensure that the stray capacitance does not cause coupling between these external parts. This can typically be detected at higher frequencies because this type of capacitance increases.



5 Electrical characteristic curves

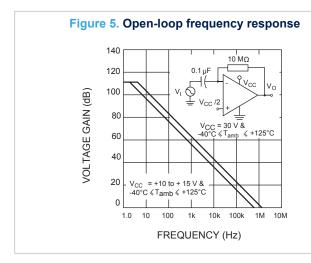


Figure 6. Large signal frequency response

20

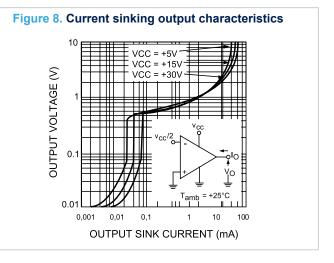
100kΩ

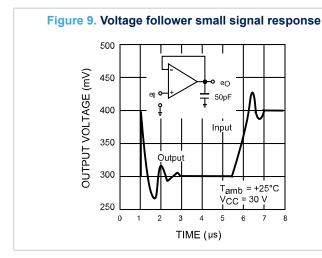
15

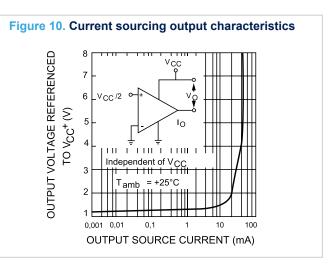
15

100kΩ

10







DS0508 - Rev 18 page 8/26



Figure 11. Input current vs. temperature

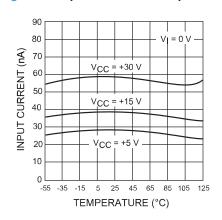


Figure 12. Current limiting

90

70

80

70

40

20

10

-55 -35 -15 5 25 45 65 85 105 125

TEMPERATURE (°C)

Figure 13. Input voltage range

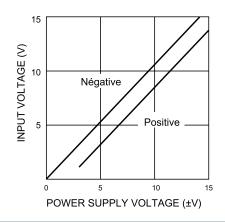


Figure 14. Supply current

Figure 15. Voltage gain

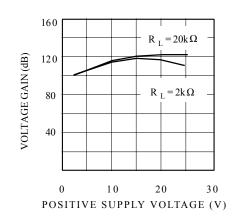
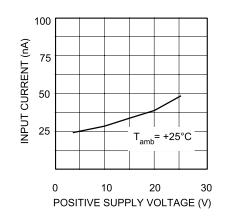


Figure 16. Input current vs. supply voltage

POSITIVE SUPPLY VOLTAGE (V)



DS0508 - Rev 18 page 9/26



Figure 17. Gain bandwidth product

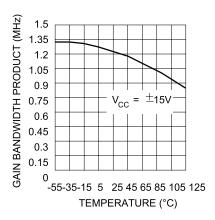


Figure 18. Power supply rejection ratio

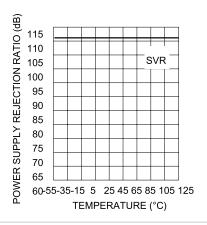


Figure 19. Common-mode rejection ratio

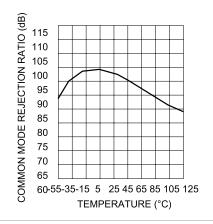
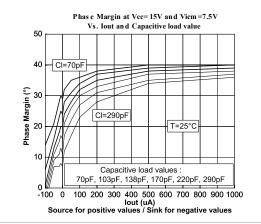


Figure 20. Phase margin vs. capacitive load



DS0508 - Rev 18 page 10/26



6 Typical single-supply applications

Figure 21. AC coupled inverting amplifier

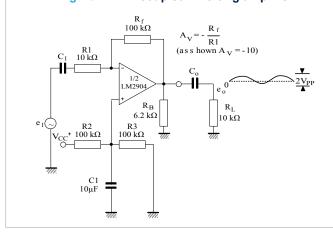


Figure 22. AC coupled non-inverting amplifier

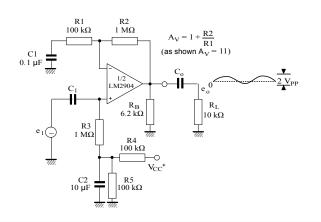


Figure 23. Non-inverting DC gain

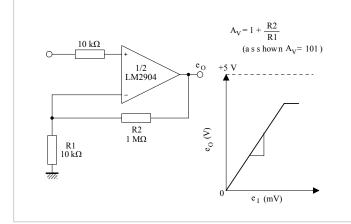


Figure 24. DC summing amplifier

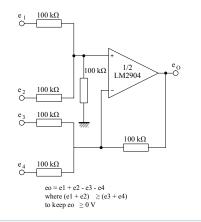


Figure 25. High input Z, DC differential amplifier

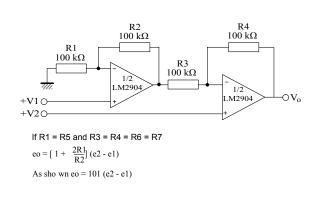
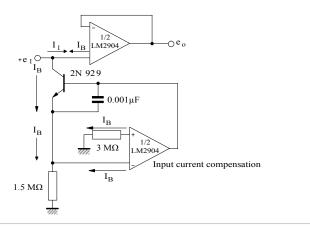


Figure 26. Using symmetrical amplifiers to reduce input current



DS0508 - Rev 18 page 11/26

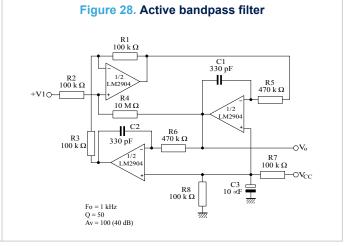


Figure 27. Low drift peak detector $\begin{array}{c|c} I_B & & & \\ \hline I_B & & & \\ I_B & & & \\ \hline I_B & & & \\ I_B & & & \\ \hline I_B & & \\ \hline I_B & & & \\ \hline I_B &$

1/2 LM2904

Input c urrent compensatio n

R 1 MΩ



DS0508 - Rev 18 page 12/26



7 Macromodel

An accurate macromodel of the LM2904, LM2904A is available on STMicroelectronics' web site at: **www.st.com**. This model is a trade-off between accuracy and complexity (that is, time simulation) of the LM2904, LM2904A operational amplifier. It emulates the nominal performances of a typical device within the specified operating conditions mentioned in the datasheet. It also helps to validate a design approach and to select the right operational amplifier, *but it does not replace on-board measurements*.

DS0508 - Rev 18 page 13/26



8 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

DS0508 - Rev 18 page 14/26



8.1 DFN8 2 x 2 package information

Figure 29. DFN8 2 x 2 package outline

Table 4. DFN8 2 x 2 mechanical data

			Dime	nsions		
Ref.		Millimeters			Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
А	0.51	0.55	0.60	0.020	0.022	0.024
A1			0.05			0.002
A3		0.15			0.006	
b	0.18	0.25	0.30	0.007	0.010	0.012
D	1.85	2.00	2.15	0.073	0.079	0.085
D2	1.45	1.60	1.70	0.057	0.063	0.067
E	1.85	2.00	2.15	0.073	0.079	0.085
E2	0.75	0.90	1.00	0.030	0.035	0.039
е		0.50			0.020	
L	0.225	0.325	0.425	0.009	0.013	0.017
ddd			0.08			0.003

DS0508 - Rev 18 page 15/26



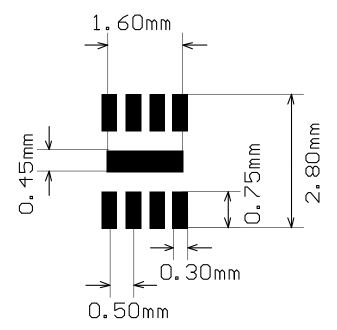


Figure 30. DFN8 2 x 2 recommended footprint

DS0508 - Rev 18 page 16/26



8.2 MiniSO8 package information

Figure 31. MiniSO8 package outline

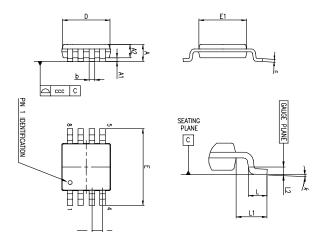


Table 5. MiniSO8 package mechanical data

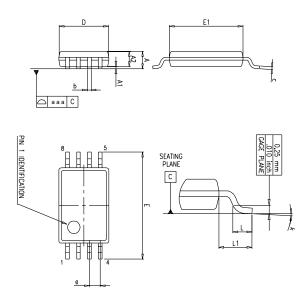
			Dime	nsions		
Ref.	Millimeters				Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
А			1.1			0.043
A1	0		0.15	0		0.0006
A2	0.75	0.85	0.95	0.030	0.033	0.037
b	0.22		0.40	0.009		0.016
С	0.08		0.23	0.003		0.009
D	2.80	3.00	3.20	0.11	0.118	0.126
E	4.65	4.90	5.15	0.183	0.193	0.203
E1	2.80	3.00	3.10	0.11	0.118	0.122
е		0.65			0.026	
L	0.40	0.60	0.80	0.016	0.024	0.031
L1		0.95			0.037	
L2		0.25			0.010	
k	0°		8°	0°		8°
ccc			0.10			0.004

DS0508 - Rev 18 page 17/26



8.3 TSSOP8 package information

Figure 32. TSSOP8 package outline



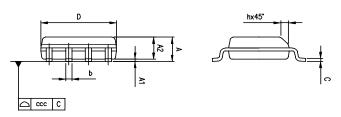
			Dimer	nsions		
Ref.		Millimeters			Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α			1.20			0.047
A1	0.05		0.15	0.002		0.006
A2	0.80	1.00	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
С	0.09		0.20	0.004		0.008
D	2.90	3.00	3.10	0.114	0.118	0.122
E	6.20	6.40	6.60	0.244	0.252	0.260
E1	4.30	4.40	4.50	0.169	0.173	0.177
е		0.65			0.0256	
k	0°		8°	0°		8°
L	0.45	0.60	0.75	0.018	0.024	0.030
L1		1			0.039	
aaa			0.10			0.004

DS0508 - Rev 18 page 18/26



8.4 SO8 package information

Figure 33. SO8 package outline



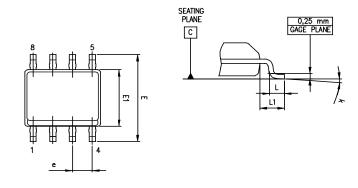


Table 6. SO8 package mechanical data

			Dime	nsions		
Ref.		Millimeters			Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
А			1.75			0.069
A1	0.10		0.25	0.004		0.010
A2	1.25			0.049		
b	0.28		0.48	0.011		0.019
С	0.17		0.23	0.007		0.010
D	4.80	4.90	5.00	0.189	0.193	0.197
Е	5.80	6.00	6.20	0.228	0.236	0.244
E1	3.80	3.90	4.00	0.150	0.154	0.157
е		1.27			0.050	
h	0.25		0.50	0.010		0.020
L	0.40		1.27	0.016		0.050
L1		1.04			0.040	
k	0°		8°	0°		8°
CCC			0.10			0.004

DS0508 - Rev 18 page 19/26



9 Ordering information

Table 7. Order codes

Order code	Temperature range	Package	Packing	Marking
LM2904D		SO8	Tube	
LM2904DT		SO8		2904
LM2904PT		TSSOP8		
LM2904ST		MiniSO8		K403
LM2904Q2T		DFN8 2x2		K1Y
LM2904YDT (1)		SO8 (automotive grade level) TSSOP8 (automotive grade level)	Tape and reel	2904Y
LM2904AYDT ⁽¹⁾				2904AY
LM2904YPT ⁽¹⁾	-40 °C to 125 °C			2904Y
LM2904AYPT (1)				904AY
LM2904YST (1)		MiniSO8 (automotive grade level)		K409
LM2904WDT		SO8		2904W
LM2904WYDT (1)		SO8 (automotive grade level)		2904WY
LM2904WYPT (1)		T00070 / / // // // // //		K04WY
LM2904AWYPT (1)		TSSOP8 (automotive grade level)		K05WY

Qualified and characterized according to AEC Q100 and Q003 or equivalent, advanced screening according to AEC Q001 & Q 002 or equivalent.

DS0508 - Rev 18 page 20/26



Revision history

Table 8. Document revision history

Date	Revision	Changes
02-Jan-2002	1	Initial release.
00 1 0005	0	PPAP references inserted in the datasheet, see Table 9 on page 21.
20-Jun-2005	2	ESD protection inserted in Table 1 on page 5.
10-Oct-2005	3	PPAP part numbers added in Table 9 on page 21.
40 Dec 2005	4	Pin connections identification added on cover page figure.
12-Dec-2005	4	Thermal resistance junction to case information added see Table 1 on page 5.
01-Feb-2006	5	Maximum junction temperature parameter added in Table 1 on page 5.
02-May-2006	6	Minimum slew rate parameter in temperature Table 3 on page 7.
13-Jul-2006	7	Modified ESD values and added explanation on V_{CC} , V_{id} in Table 1 on page 5. Added macromodel information.
		Modified ESD/HBM values in Table 1 on page 5.
28-Feb-2007	8	Updated MiniSO8 package information.
		Added note relative to automotive grade level part numbers in Table 9 on page 21.
		Power dissipation value corrected in Table 1: Absolute maximum ratings.
		Table 2: Operating conditions added.
18-Jun-2007	9	Equivalent input noise voltage parameter added in Table 3.
		Electrical characteristics curves updated. Figure 19: Phase margin vs capacitive load added.
		Section 6: Package information updated.
		Removed power dissipation parameter from Table 1: Absolute maximum ratings.
18-Dec-2007	10	Removed V _{opp} from electrical characteristics in Table 3.
		Corrected MiniSO8 package mechanical data in Section 6.4: MiniSO8 package information.
		Added table of contents.
08-Apr-2008	11	Corrected the scale of Figure 7 (mA not µA).
		Corrected SO8 package information.
		Added input current information in Table 1: Absolute maximum ratings.
02-Jun-2009	12	Added L1 parameters in Table 6: SO8 package mechanical data.
		Added new order codes, LM2904AYD/DT, LM2904AYPT and LM2904AYST in Table 9: Order codes.
		Added LM2904A on cover page.
13-Apr-2010	13	Corrected footnote (5) in Table 1: Absolute maximum ratings.
		Removed order code LM2904AYST from Table 9: Order codes.
		Removed macromodel from Chapter 5 (now available on www.st.com).
24-Jan-2012	14	Added DFN8 2 x 2 mm package information in Chapter 6 and related order codes in Chapter 7.
		Removed LM2904YD and LM2904AYD order codes from Table 9.
		Changed note for LM2904YST order code in Table 9.
24-Jan-2014	15	Updated: marking info for LM2904AYPT, package silhouette drawings in the cover page, $\Delta V_{io}/\Delta T$ and $\Delta I_{io}/\Delta T$ symbols in Table 3 on page 7
∠ 1 -Ja∏-∠U 14	15	Added: ESD info in Features section and Section 2: Package pin connections
		Removed: LM2904N from Table 9: Order codes.
02-Oct-2015	16	Figure 1: Schematic diagram (1/2 LM2904, LM2904A): updated

DS0508 - Rev 18 page 21/26



Date	Revision	Changes
	17	Updated layout
16-Feb-2016		Removed "plastic micropackage" from SO8 and DFN8 2x2 package silhouettes; removed "thin shrink small outline package" from TSSOP8 package silhouette
		Table 3: unit of V _{OL} parameter changed from "V" to 'mV"
		DFN8 2x2 package information: updated "L"
		TSSOP8 package information: "aaa" is a typ. value not a max value
45 Fab 2040	18	Added new part numbers LM2904W, LM2904AW, Figure 2. Schematic diagram (LM2904W, LM2904AW) and Table 2. Operating conditions.
15-Feb-2019		Updated: Table 1. Absolute maximum ratings, Section 4 Electrical characteristics and Section 9 Ordering information

DS0508 - Rev 18 page 22/26



Contents

1	Sch	ematic diagram	2		
2	Package pin connections				
3	Abs	olute maximum ratings and operating conditions	4		
4	Elec	trical characteristics	6		
5	Electrical characteristic curves				
6	Турі	cal single-supply applications	11		
7	Мас	romodel	13		
8	Pacl	kage information	14		
	8.1	DFN8 2 x 2 package information	15		
	8.2	MiniSO8 package information	17		
	8.3	TSSOP8 package information	17		
	8.4	SO8 package information	18		
9		ering information			
Rev	ision	history	21		
Con	tents		23		
List	of tal	bles	24		
List	of fig	jures	25		





List of tables

Table 1.	Absolute maximum ratings	. 4
Table 2.	Operating conditions	. 5
Table 3.	V_{CC}^{+} = 5 V, V_{CC}^{-} = ground, V_{O} = 1.4 V, R_{L} connected to GND, T_{amb} = 25 °C (unless otherwise specified)	. 6
Table 4.	DFN8 2 x 2 mechanical data	15
Table 5.	MiniSO8 package mechanical data	17
Table 6.	SO8 package mechanical data	19
Table 7.	Order codes	20
Table 8.	Document revision history	21

DS0508 - Rev 18 page 24/26



List of figures

Figure 1.	Schematic diagram (LM2904, LM2904A)	. 2
Figure 2.	Schematic diagram (LM2904W, LM2904AW)	. 2
Figure 3.	DFN8 2x2 package pin connections (top view)	. 3
Figure 4.	MiniSO8, TSSOP8, and SO8 package pin connections (top view)	. 3
Figure 5.	Open-loop frequency response	. 8
Figure 6.	Large signal frequency response	. 8
Figure 7.	Voltage follower large signal response	. 8
Figure 8.	Current sinking output characteristics	. 8
Figure 9.	Voltage follower small signal response	. 8
Figure 10.	Current sourcing output characteristics	. 8
Figure 11.	Input current vs. temperature	. 9
Figure 12.	Current limiting	. 9
Figure 13.	Input voltage range	. 9
Figure 14.	Supply current	. 9
Figure 15.	Voltage gain	. 9
Figure 16.	Input current vs. supply voltage	. 9
Figure 17.	Gain bandwidth product	10
Figure 18.	Power supply rejection ratio	10
Figure 19.	Common-mode rejection ratio	10
Figure 20.	Phase margin vs. capacitive load	10
Figure 21.	AC coupled inverting amplifier	11
Figure 22.	AC coupled non-inverting amplifier	11
Figure 23.	Non-inverting DC gain	11
Figure 24.	DC summing amplifier	11
Figure 25.	High input Z, DC differential amplifier	11
Figure 26.	Using symmetrical amplifiers to reduce input current	11
Figure 27.	Low drift peak detector	12
Figure 28.	Active bandpass filter	12
Figure 29.	DFN8 2 x 2 package outline	15
Figure 30.	DFN8 2 x 2 recommended footprint	16
Figure 31.	MiniSO8 package outline	17
Figure 32.	TSSOP8 package outline	18
Figure 33.	SO8 package outline	19

DS0508 - Rev 18 page 25/26



IMPORTANT NOTICE - PLEASE READ CAREFULLY

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2019 STMicroelectronics - All rights reserved

DS0508 - Rev 18 page 26/26

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

STMicroelectronics:

<u>LM2904D LM2904N LM2904DT LM2904PT LM2904AYPT LM2904ST LM2904Q2T LM2904YST LM2904YPT LM2904YDT LM2904AYDT</u>